



ATTY DKT. NO.: AMAT/5619/DSM/LOW K/JW  
U.S. SERIAL NO.: 09/012,103  
FILED: JULY 23, 2001  
APPLICANT: APPLIED MATERIALS, INC.  
TITLE: SELECTIVE ETCHING OF ORGANOSILICATE FILMS OVER  
SILICON OXIDE STOP ETCH LAYERS  
INVENTOR: NGUYEN, ET AL.  
EXPRESS MAIL NO.: N/A

CONF. NO.: 447

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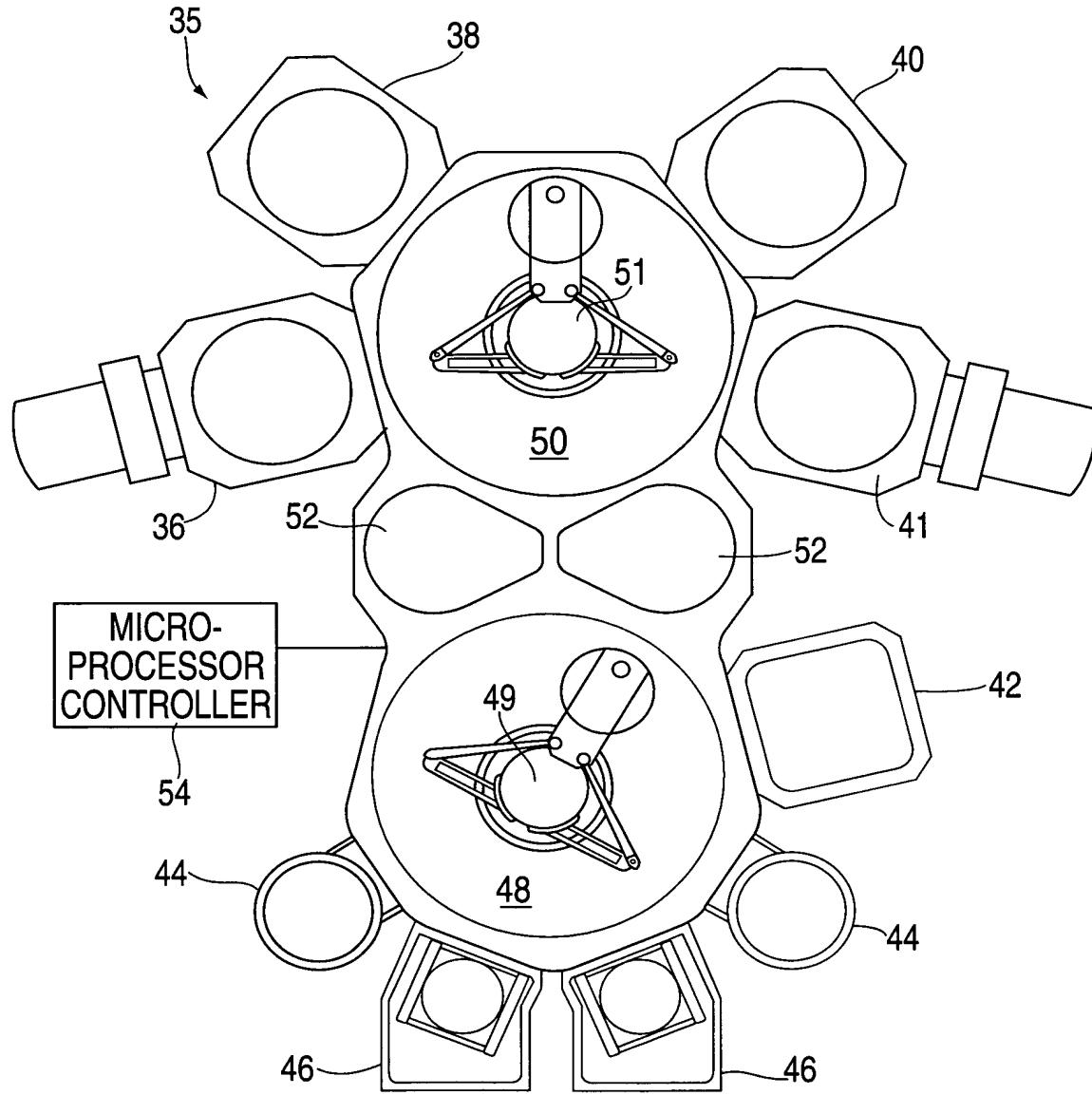


FIG. 1

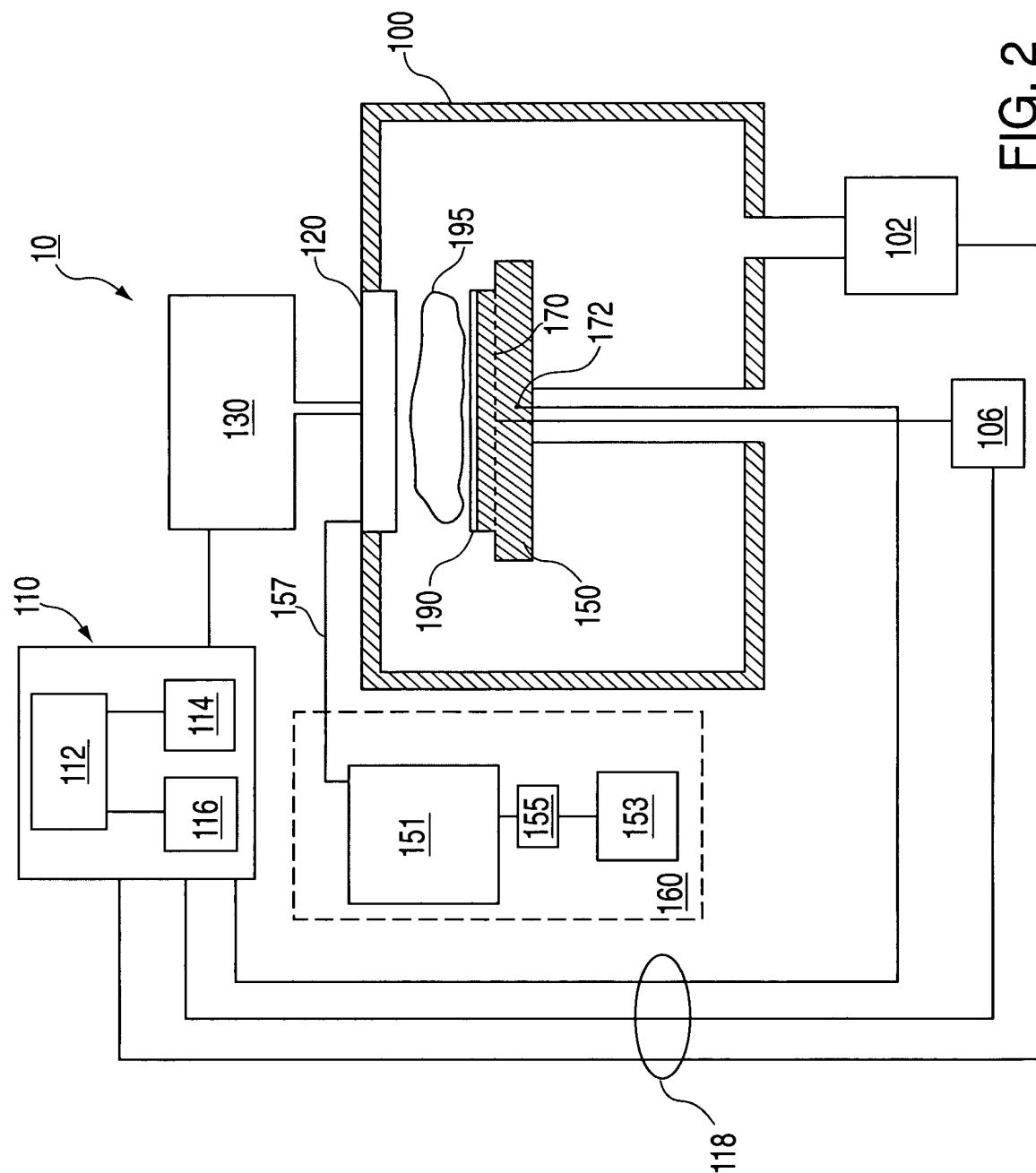


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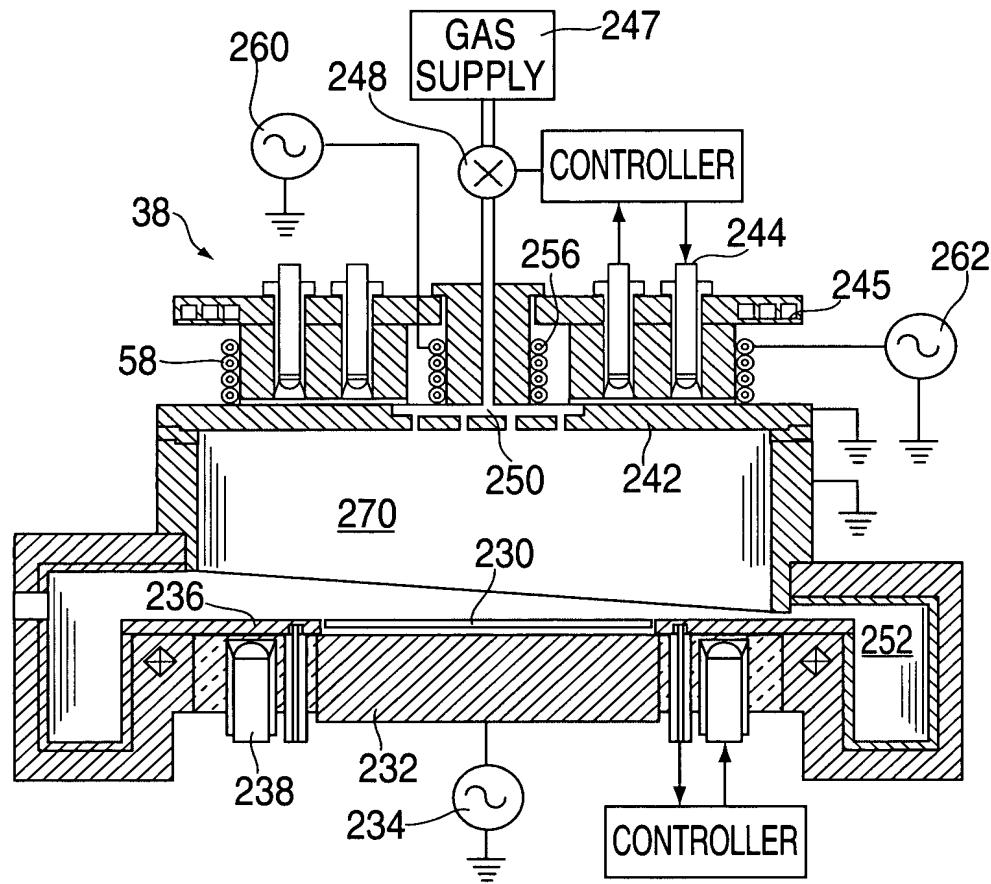


FIG. 3

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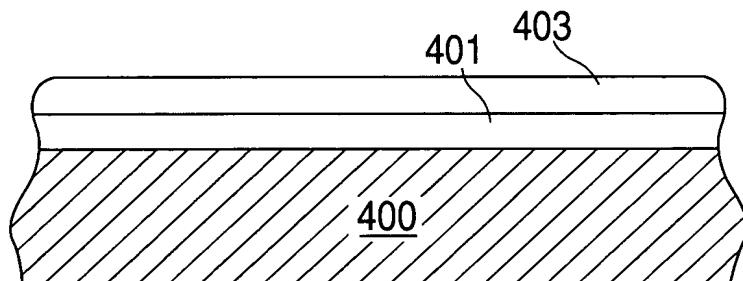


FIG. 4a

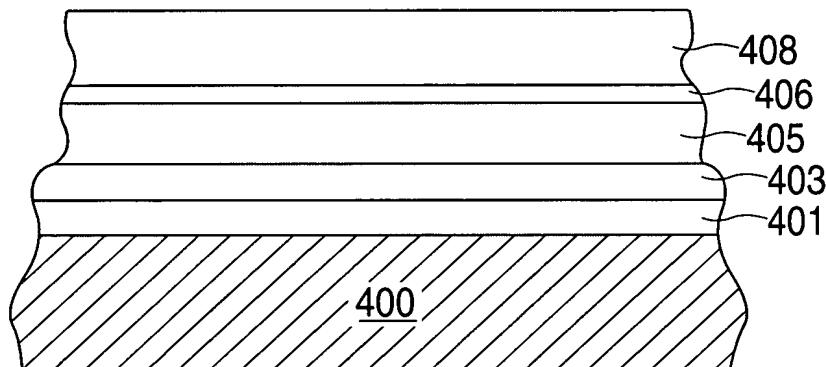


FIG. 4b

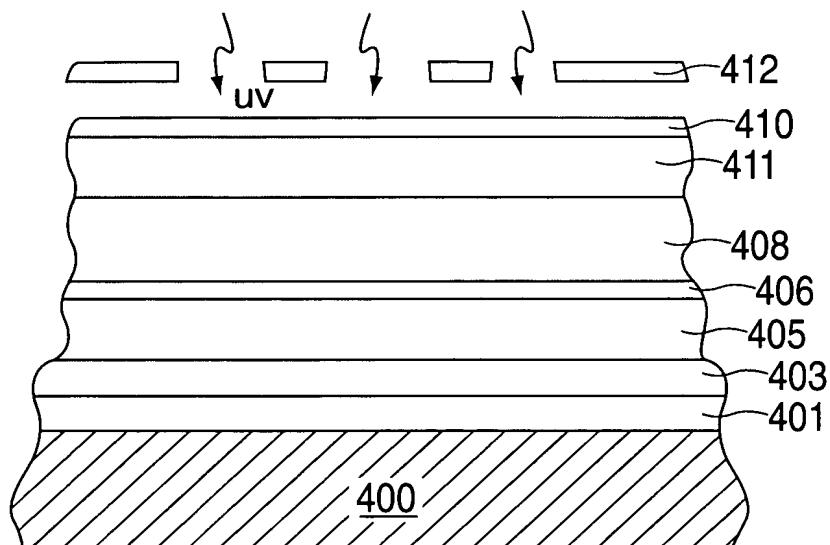


FIG. 4c



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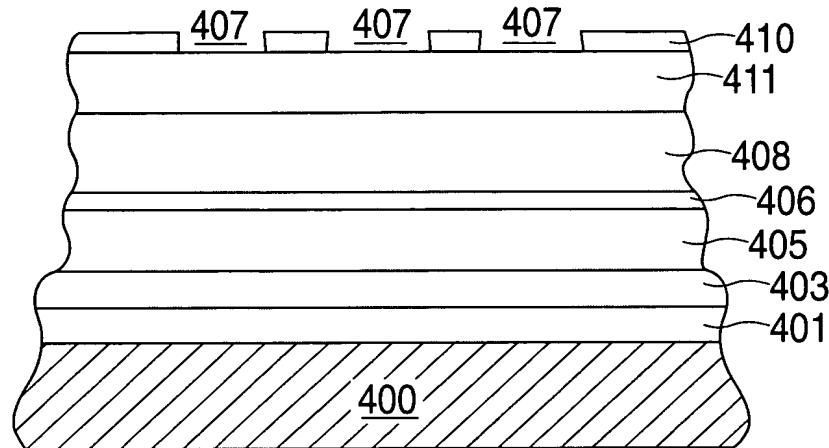


FIG. 4d

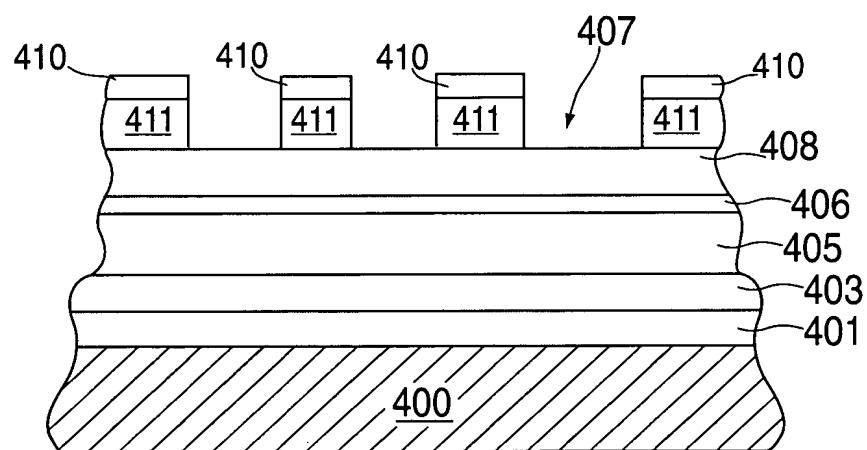


FIG. 4e



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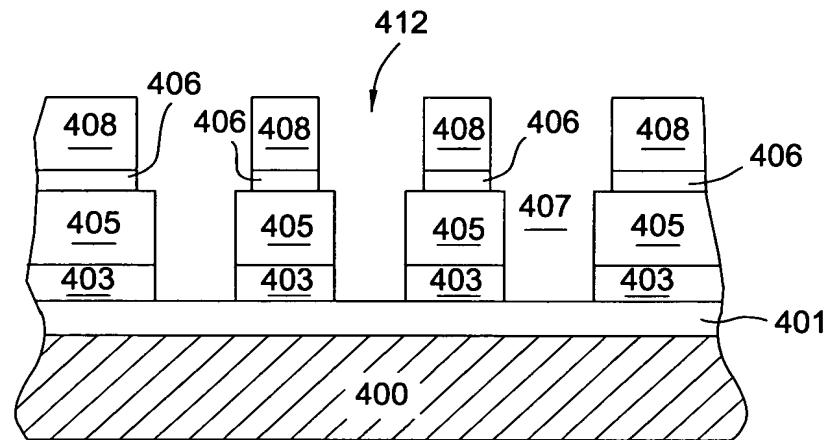


FIG. 4F

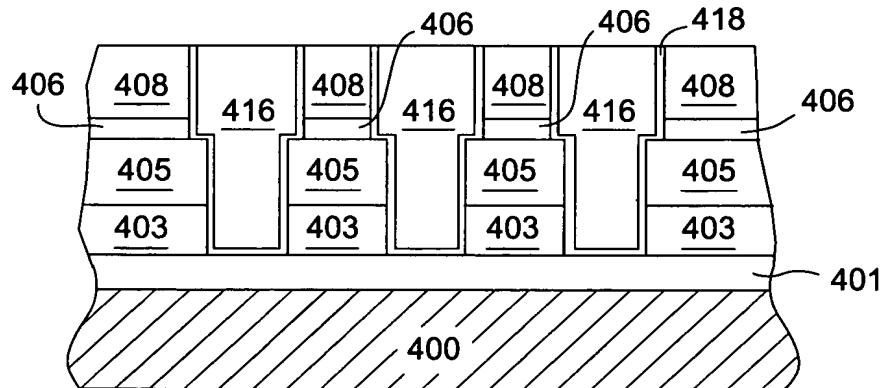


FIG. 4G